

# **NX2016SF**

## For Mobile Communications

## **■** Features

Crystal Unit with built-in Thermistor construction.

- Minimize circuit design space by combining crystal unit into one component. (Presently, Crystal unit and temperature sensor is mounted in one board separately.)
- Placing temperature sensor(Thermistor) close to Crystal blank in one airtight housing can detect more precise crystal blank temperature. Improvement on frequency temperature compensation compared to present Crystal unit.
- Single cavity housing which is ideal to module applications.
- External configuration size is 2.0x1.6mm typ., H0.65 mm max.
- A surface-mount crystal oscillator. (Reflow soldering is possible.)
- Lead-free. Meets the requirements for re-flow profiling using lead-free solder.







## ■ Specifications

ltem Model	NX2016SF
Nominal Frequency	19.2 to 52 MHz
Overtone Order	Fundamental
Frequency Tolerance (25 ± 3°C )	±10 × 10 <sup>-6</sup>
Frequency versus Temperature Characteristics (with reference to +32 °C)	±12 × 10 <sup>-6</sup>
Operating Temperature Range	−30 to +85 °C
Storage Temperature Range	-40 to +85 °C
Equivalent Series Resistance	Refer to *1
Level of Drive	10 μW
Load Capacitance	7 pF
Specifications Number	STD-CTZ-1

#### NTC Thermistor for Temperature Sensor

Resistance [R25]	100k Ω ± 1 %
B-Constant [B25-50]	4250K ± 1 %

#### **■** Dimensions







